# **IMX8MNLPD4EVKHUG**

## i.MX 8M Nano LPDDR4 EVK Board Hardware User's Guide

Rev. 2 — 19 September 2023

User guide

#### **Document Information**

Information	Content
Keywords	i.MX 8M Nano, i.MX 8M Nano LPDDR4 Evaluation Kit (EVK), i.MX 8M Nano Applications Processor.
Abstract	This document is the hardware user's guide for the i.MX 8M Nano LPDDR4 Evaluation Kit (EVK) based on the NXP Semiconductor's i.MX 8M Nano Applications Processor. The document includes system setup and configurations and provides detailed information on the overall design and usage of the EVK board from a hardware system perspective.



## 1 Introduction

This document is the hardware user's guide for the i.MX 8M Nano LPDDR4 Evaluation Kit (EVK) based on the NXP Semiconductor's i.MX 8M Nano Applications Processor. This board is fully supported by NXP Semiconductors. This manual includes system setup and configurations and provides detailed information on the overall design and usage of the EVK board from a hardware system perspective.

#### 1.1 Board overview

The LPDDR4 EVK board is a platform designed to show the most commonly used features of the i.MX 8M Nano Applications Processor. The i.MX 8M Nano LPDDR4 EVK board helps developers get familiar with the processor before investing a large amount of resources in more specific designs.

Table 1 lists the features of the i.MX 8M Nano LPDDR4 EVK board.

Table 1. Board features

Processor	NXP Applications Processor	MIMX8MN6DVTJZAA	
DRAM memory	Kingston 16 GB LPDDR4	C1612PC2WDGTKR-U	
	SanDisk 32 GB eMMC5.1	SDINBDG4-32G-I1	
Mass storage	Micron 32 MB QSPI NOR	MT25QU256ABA1EW7-0SIT	
	MicroSD card connector	SD3.0 supported	
Power	NXP PMIC PCA9450B + Discrete DCDC	/LDO	
Camera	CSI interface (Mini-SAS connector)		
Display interface	DSI interface (Mini-SAS connector)		
Ethernet	1 GB Ethernet with RJ45 connector		
USB	Port1 is USB (2.0) Type-C connector and Port2 is used as the Power Input.		
Wi-Fi/Bluetooth	x1 on board Wi-Fi/Bluetooth module AW-CM358SM based on NXP 88W8987, 802.11a/b/g/n/ac, BT5.0		
Audio connectors	3.5 mm Stereo Line output, 2 Vrms		
Addio connectors	FPC connector (SAI ports) for Audio Card		
Debug connectors	JTAG (10-pin header)		
Debug connectors	MicroUSB for UART debug, two COM Ports for A53 and M7		
Expansion connector	40-pin dual-row Pin Header for I <sup>2</sup> S, UAR	Γ, I <sup>2</sup> C, and GPIO expansion	
I <sup>2</sup> C connector	8-pin dual-row Pin Header for I <sup>2</sup> C expansion		
Buttons	ON/OFF, RESET		
LED indicators	Power status, UART		
РСВ	8MNANOLPD4-CPU: 2 inch × 2.7 inch, 6-layer 8MMINI-BB: 4 inch × 4.2 inch, 8-layer		
Orderable part number	8MNANOLPD4-EVK <sup>[1]</sup>		

<sup>[1]</sup> It consists of 8MNANOLPD4-CPU plus 8MMINI-BB. The boards are not orderable separately.

#### 1.2 Board contents

The i.MX 8M Nano LPDDR4 EVK contains the following items:

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- i.MX 8M Nano LPDDR4 EVK board, assembled by two separate boards, 8MNANOLPD4-CPU (SOM Board) and 8MMINI-BB (Base Board)
- IMX-MIPI-HDMI Accessory Card, MIPI-DSI to HDMI adapter board
- USB-Type C 45 W Power Delivery Supply, 5V/3A, 9V/3A, 15V/3A, 20V/2.25A supported
- Mini-SAS cable, 8" mini-SAS cable
- USB-Type C Cable, Cable Assembly, USB 3.0, Type-C Male to Type-A Male
- USB micro-B Cable, Cable Assembly, USB 2.0, Type-A Male to Micro-B Male
- USB-Type C to A Adapter, Adapter USB 3.0, Type-C Male to Type-A Female
- · Quick Start Guide

## 2 Specifications

This section provides detailed information about the electrical design and practical considerations on the LPDDR4 EVK board. Figure 1 describes each block in the high-level block diagram of the LPDDR4 EVK board.

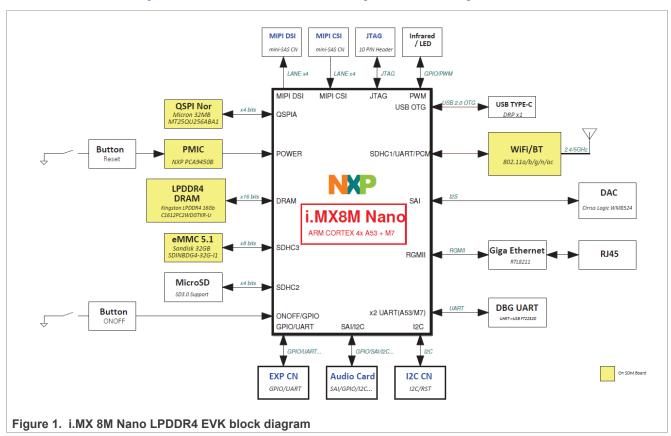
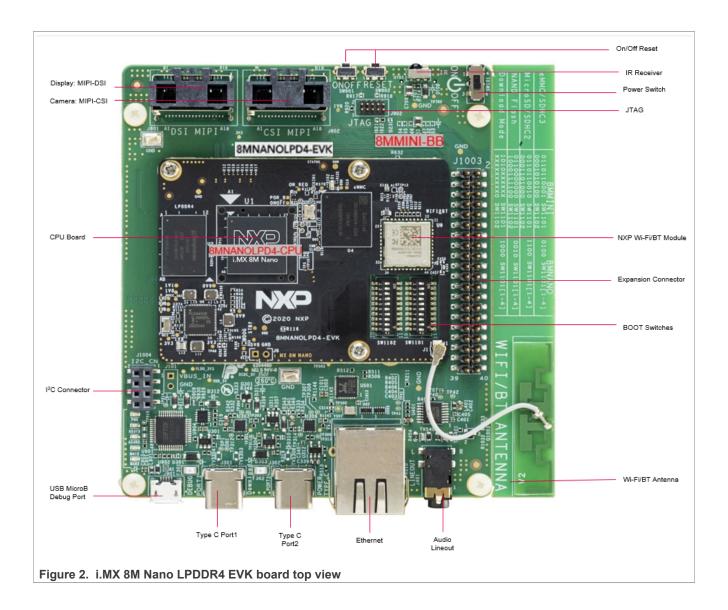
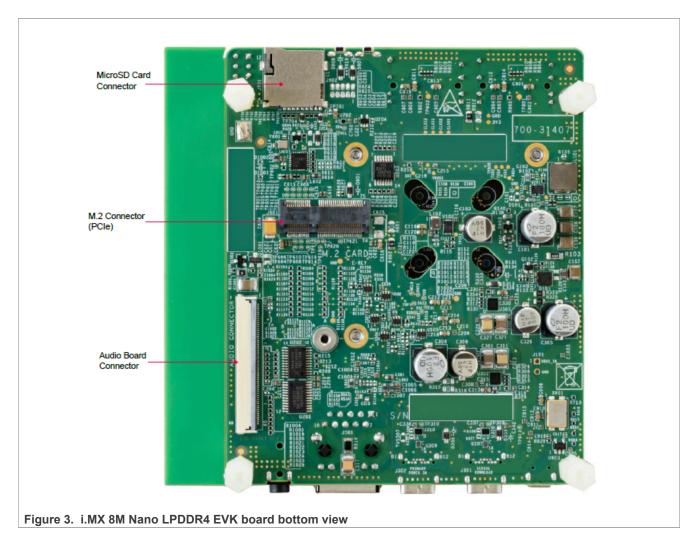


Figure 2 and Figure 3 show the overview of the i.MX 8M Nano LPDDR4 EVK board.





#### Note:

Type-C Port2 is the only power supply port, and it must be always supplied for system running.

i.MX 8M Nano EVK is not a typical use case of the PD device. It is supplied by the PD charger only, but with a power switch. When the switch keeps **OFF** for more than 5.5 seconds after adapting the PD charger, the charger (Source) will repower EVK (Sink) after the system initiates the PD software. For more information, visit the following link.

There are two ways to avoid the repower:

- The power switch must always be in the **ON** position before attaching the PD charger.
- Change the software to disable the PD function, and make it Type-C supply only.

#### 2.1 Processor

The i.MX 8M Nano applications processors represent NXP Semiconductor's latest achievement in highly integrated multimedia-focused products offering high-performance processing. These application processors can enable the growing market of smart, secure, connected devices. The i.MX 8M Nano applications processors feature NXP's advanced implementation of the Quad ARM Cortex-A53+ ARM Cortex-M7 cores, which operate at speeds up to 1.5 GHz and 750 MHz respectively. Each i.MX 8M Nano device provides a 16-bit DDR3L/DDR4/LPDDR4 memory interface and other interfaces for connecting peripherals, such as MIPI LCD, MIPI Camera, WLAN, Bluetooth, Ethernet, Digital Mic, and multisensors.

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For more detailed information about the processor, see the datasheet and reference manual on i.MX 8M NANO.

## 2.2 Boot mode and boot device configurations

The i.MX 8M Nano implements a compressed boot mode decode with four BOOT\_MODE pins. It can boot from the boot configuration selected on SW1101 or from the boot configuration stored on the internal eFUSE. In addition, the i.MX 8M Nano can download a program image from a USB connection when configured in the serial downloader mode. The method used to determine where the processor finds its boot information is from four dedicated BOOT MODE pins.

On the i.MX 8M Nano LPDDR4 EVK board, the default boot mode is to boot from the eMMC device. There are two additional boot devices: one QSPI Nor Flash on the CPU board and one MicroSD connector on the base board. If you set the boot device to QSPI or MicroSD, the board boots from the device accordingly.

Table 2 shows the values used for boot selection.

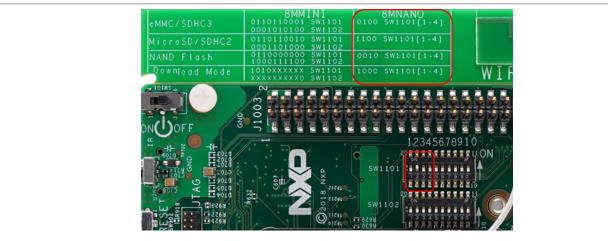


Figure 4. Boot selection

Table 2. Boot selection

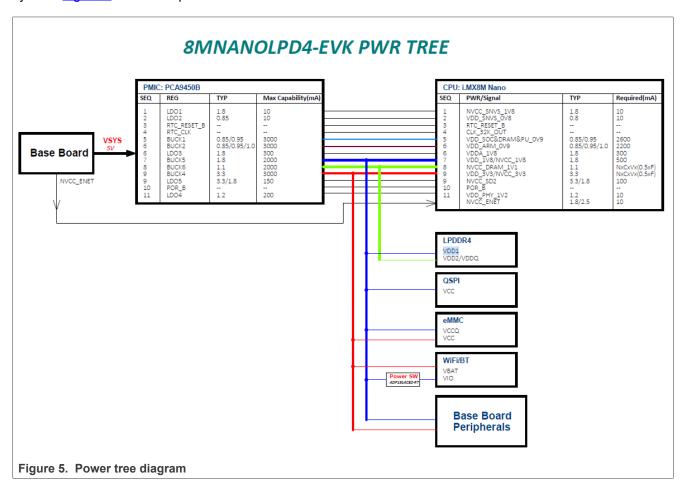
able 2. Boot selection				
BOOT_MODE3 (SW1101 pin4)	BOOT_MODE2 (SW1101 pin3)	BOOT_MODE1 (SW1101 pin2)	BOOT_MODE0 (SW1101 pin1)	Boot device
0	0	0	0	Boot from fuses
0	0	0	1	Serial downloader
0	0	1	0	eMMC/uSDHC3
0	0	1	1	MicroSD/uSDHC2
0	1	0	0	NAND Flash
0	1	1	0	QSPI 3B Read
0	1	1	1	QSPI Hyperflash 3.3 V
1	0	0	0	ecSPI Boot

**Note:** Only SW1101[1-4] are used for boot selection. The left pins of SW1101 and SW1102 are useless for the i.MX 8M Nano. Either 0 or 1 is acceptable.

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#### 2.3 Power tree

There is a Type-C power supply that must be connected to the i.MX 8M Nano LPDDR4 EVK board at connector J302. The other powers on the EVK board are generated from PMIC and discrete devices to supply the whole system. Figure 5 shows the power tree.



In <u>Figure 5</u>, the developer can get all the voltage supply rails used on the EVK board. When some modules are not enabled, the power supplies might be shut down by software. <u>Table 3</u> lists the power rails on the board.

Table 3. Power rails

SEQ	Power rail	Regulator	Value/V
0	VSYS_5V	From baseboard	5
1	NVCC_SNVS_1V8	PCA9450B LDO1	1.8
2	VDD_SNVS_0V8	PCA9450B LDO2	0.8
3	RTC_RESET_B	PCA9450B	-
4	CLK_32K_OUT	PCA9450B	_
5	VDD_SOC_DRAM_PU_0V9	PCA9450B BUCK1	0.85/0.95 <sup>[1]</sup>
6	VDD_ARM_0V9	PCA9450B BUCK2	0.85/0.95/1.0 <sup>[2]</sup>
6	VDDA_1V8	PCA9450B LDO3	1.8
7	VDD_1V8/NVCC_1V8	PCA9450B BUCK5	1.8

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Table 3. Power rails...continued

SEQ	Power rail	Regulator	Value/V
8	NVCC_DRAM_1V1	PCA9450B BUCK6	1.1
9	VDD_3V3/NVCC_3V3	PCA9450B BUCK4	3.3
9	NVCC_SD2	PCA9450B LDO5	3.3/1.8
10	POR_B	PCA9450B	_
11	VDD_PHY_1V2	PCA9450B LDO6	1.2

<sup>[1]</sup> PCA9450B BUCK1 default output voltage is 0.85 V. The software changes it to 0.95 V for overdrive mode in SPL before DDR initialization.

## 2.4 LPDDR4 DRAM memory

The i.MX 8M Nano LPDDR4 EVK board has one 16-bit LPDDR4 SDRAM chip (C1612PC2WDGTKR-U) for a total of 2 GB RAM memory.

In the physical layout, the LPDDR4 chip is placed on the TOP side. The data traces are not necessarily connected to the LPDDR4 chips in sequential order, but for ease of routing, are connected as best determined by the layout and other critical traces.

The DRAM\_VREF can be generated by the i.MX 8M Nano internally, so it does not need to use an external power supply and decoupling capacitors. The calibration resistors used by the LPDDR4 chips and processor are 240 Ohm 1% resistors. The differential termination resistors for DRAM Clock are one 150 ohm 1% resistor on EVK. Developers can change this value depending on simulation and the test result.

## 2.5 eMMC memory (U4)

The eMMC memory is connected to the uSDHC3 interface of i.MX 8M Nano, and it can support up to eMMC 5.1 device. The eMMC memory is on the 8MNANOLPD4-CPU board, and the part number is SDINBDG4-32G-I1. It is the default boot device of the EVK. The boot settings are as shown in <u>Table 2</u>.

#### 2.6 QSPI Nor Flash (U5)

The QSPI memory is connected to the FlexSPI interface of i.MX 8M Nano, and it can support up to 166 MHz DDR mode device. The QSPI memory is on the 8MNANOPLPD4-CPU board, and the part number is MT25QU256ABA1EW7-0SIT. To select it as the boot device of the EVK, developers can refer to the boot settings as shown in Table 2.

### 2.7 SD card slot (J701)

There is one MicroSD card slot (J701) on the 8MMINI-BB board, connecting to the uSDHC2 interface of the i.MX 8M Nano. This connector supports one 4-bit SD3.0 MicroSD card. To select it as the boot device of the EVK, developers can refer to the boot settings as shown in <u>Table 2</u>.

#### 2.8 MIPI-CSI and MIPI-DSI connectors (J802, J801)

The i.MX 8M Nano processor supports one 4-lane MIPI-CSI and one 4-lane MIPI-DSI. The MiniSAS connectors are designed to support camera and LCD with dedicated pin definition. The connectors are as shown in <a href="Figure 2">Figure 2</a>. Display and camera accessory boards are available separately. The full list can be found at i.MX 8 <a href="Series Accessory Boards">Series Accessory Boards</a>.

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<sup>[2]</sup> BUCK2 default output voltage is 0.85 V. Software changes it to 0.95 V for 1.4 GHz and to 1.0 V for 1.5 GHz.

### 2.9 Ethernet connector (J501)

The Ethernet subsystem of the EVK board is provided by the RTL8211 Ethernet Transceiver (U501). The Ethernet Transceiver (RTL8211) receives standard RGMII Ethernet signals from the MAC-NET core of the i.MX 8M Nano. The processor handles all Ethernet protocols at the MAC layer and above. RTL8211 is only responsible for the Link Layer formatting. The Ethernet connector (J501) integrates a Magnetic transformer inside, so it cannot be directly connected to RTL8211 (U501).

Each EVK board has a unique MAC address, which is burned into the i.MX 8M Nano by Fuse. A label with the unique MAC address is placed on the connector for reference.

#### 2.10 USB connector (J301, J302)

The i.MX 8M Nano Applications Processors contain one USB 2.0 OTG controller, with one integrated USB PHY. There are two USB Type-C connectors on the EVK board, but only Port1 can support Host and Device Mode.

J301 is connected to USB1 interface of the i.MX 8M Nano, which can act as the download port of the EVK. J302 is the power supply port of the EVK.

#### 2.11 Wi-Fi/Bluetooth (U9)

The EVK board has a Wi-Fi/Bluetooth module AW-CM358SM on the 8MNANOLPD4-CPU board. The module is NXP 88W8987 based, contains SDIO3.0, UART, PCM interface, and can support 802.11a/b/g/n/ac, BT5.0. The 2.4G/5G antenna is stuck to the edge of the Base Board with a coaxial cable connected to the CPU Board.

## 2.12 Audio line output (J401)

The EVK board uses a high-quality Stereo DAC WM8524 (U401), which can support 24 bit I2S data and 192 KHz sampling rate. The Line output of WM8524 is **2 Vrms**, not like common headphone output 1 Vrms. Developers must be careful about this interface. The Line output connector (J401) is a 3.5 mm 4-pole (or TRRS) phone jack.

**Note:** The Audio Line output connector is designed for an active speaker with a power amplifier. To connect it with a headphone, make sure that the headphone has volume control functionality and set the headphone's volume properly before wearing it. Do not plug in the non-volume-control headphone directly. The audio output volume may be too high for a non-volume-control headphone and may damage it.

## 2.13 Audio card connector (J1001)

One 60-pin FPC connector (J1001) is provided on the EVK board to support audio card connection, and the developers can use the audio card to perform audio features development.

**Note:** There is no SAI1 from the i.MX 8M Nano process, so AK4458/AK4497 ca not be enabled on an audio card.

### 2.14 JTAG connector (J902)

The i.MX 8M Nano Applications Processor has four JATG signals on dedicated pins, and one HW reset input signal POR\_B. Those signals are directly connected to the 10-pin 1.27 mm JTAG connector J902. The four JTAG signals used by the processor are:

- JTAG TCK: TAP Clock
- JTAG TMS: TAP Machine State
- JTAG TDI: TAP Data In

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• JTAG TDO: TAP Data Out

## 2.15 USB-UART connector (J901)

The i.MX 8M Nano Applications Processor has four independent UART ports, UART1 - UART4. On the EVK board, UART2 is used for Cortex-A53 core and UART4 is used for Cortex-M7 core. We use a single-chip USB to dual-channel UART IC for system debugging, and the part number is FT2232D. The developers can download the driver from FTDI. After the driver for FT2232D is installed, the PC will enumerate two COM ports when the USB cable is plugged into J901. Developers can use Putty, Tera Term, Xshell, or other terminal tools. The required settings are as listed in Table 4.

Table 4. Terminal setting parameters

Data rate	115,200 baud
Data bits	8
Parity	None
Stop bits	1

## 2.16 Expansion connector (J1003)

One 40-pin dual-row Pin Header connector, **J1003**, is provided on the EVK board to support I<sup>2</sup>S, UART, I2C, and GPIO connection. The developers can use the port for some specific application development.

Table 5. J1003 pin definition

No.	Net name	Description	No.	Net name	Description
1	VEXT_3V3	Power Output, 3.3 V	2	VDD_5V	Power Output, 5 V
3	I2C3_SDA_3V3	I2C3 data signal	4	VDD_5V	Power Output, 5 V
5	I2C3_SCL_3V3	I2C3 clock signal	6	GND	Ground
7	UART3_CTS	UART3 clear to send signal	8	UART3_TXD	UART3 transmit signal
9	GND	Ground	10	UART3_RXD	UART3 transmit signal
11	UART3_RTS	UART3 request to send signal	12	EXP_IO8	Expansion IO signal
13	EXP_IO9	Expansion IO signal	14	GND	Ground
15	EXP_IO10	Expansion IO signal	16	EXP_IO11	Expansion IO signal
17	VEXT_3V3	Power Output, 3.3 V	18	_	NC
19	ECSPI2_MOSI	SPI2 data signal, master output slave input	20	GND	Ground
21	ECSPI2_MISO	SPI2 data signal, master input slave output	22	_	NC
23	ECSPI2_SCLK	SPI2 clock signal	24	ECSPI2_SS0	SPI2 chip select signal
25	GND	Ground	26	_	NC
27	_	NC	28	_	NC
29	_	NC	30	GND	Ground
31	EXP_IO14	Expansion IO signal	32	EXP_IO12	Expansion IO signal
33	EXP_IO13	Expansion IO signal	34	GND	Ground
35	SAI5_RXD3	SAI5 receive data signal	36	SAI5_RXD2	SAI5 receive data signal

Table 5. J1003 pin definition...continued

No.	Net name	Description	No.	Net name	Description
37	SAI5_RXD1	SAI5 receive data signal	38	SAI5_RXD0	SAI5 receive data signal
39	GND	Ground	40	SAI5_RXC	SAI5 receive clock signal

## 2.17 I<sup>2</sup>C connector (J1004)

One 8-pin dual-row Pin Header connector (J1004) is provided on the EVK board to support I<sup>2</sup>C connection. The developers can use the port for some specific application development.

Table 6. J1004 pin definition

No.	Net name	Description
1/2	VDD_3V3	Power Output, 3.3 V
3/4	I2C3_SCL_3V3	I <sup>2</sup> C clock signal
5/6	I2C3_SDA_3V3	I <sup>2</sup> C data signal
7/8	GND	Ground

#### 2.18 User interface buttons

There are two user interface buttons on the EVK board.

#### 2.18.1 Power button (SW901)

The i.MX 8M Nano Applications Processor supports the use of a button input signal to request main SoC power state changes, such as, ON or OFF, from the PMU.

The ON/OFF button can be used for debounce, OFF-to-ON time, and max timeout. Debounce is used to generate the power-off interrupt. In the ON state, if the **ON/OFF** button is held longer than the debounce time, the power-off interrupt is generated. In the OFF state, if the **ON/OFF** button is held longer than the OFF-to-ON time, the state will transit from OFF to ON. Max timeout can also be the time for requesting physical power down after the **ON/OFF** button has been held for the defined time.

#### 2.18.2 Reset button (SW902)

The **RESET** button, SW902, is directly connected to the PMIC PCA9450B. Holding the **RESET** button forces to reset the PMIC power outputs except NVCC\_SNVS\_1V8 and VDD\_SNVS\_0V8 on the EVK board. The i.MX 8M Nano applications processor is immediately turned off and reinitiate a boot cycle from the OFF state.

#### 2.19 User interface LED indicators

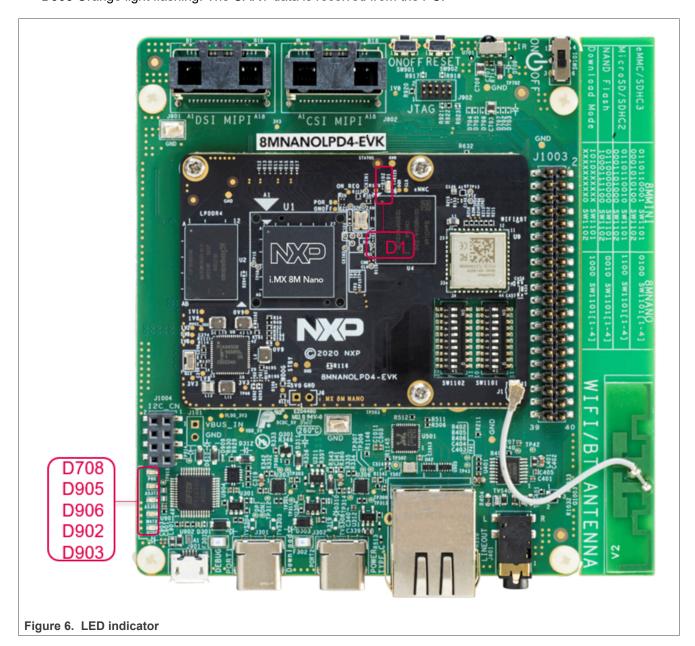
There are four LED indicators on the board. These LEDs have the following functions:

- · Main power supply, D708:
  - Green: The board is powered on.
  - OFF: The board is powered off.
- · System status, D1, on 8MNANOLPD4-CPU
  - Green blinking: The CPU is running well.
  - OFF: The CPU is not running.
- M7 UART, D902/D903
  - D902 Green light flashing: The UART data is transmitted to the PC.

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- D903 Orange light flashing: The UART data is received from the PC.
- A53 UART, D906/D905
  - D906 Green light flashing: The UART data is transmitted to the PC.
  - D905 Orange light flashing: The UART data is received from the PC.



## 3 PCB information

The i.MX 8M Nano LPDDR4 EVK is composed by 8MNANOLPD4-CPU and 8MMINI-BB. <u>Table 1</u> lists the dimensions of the two boards. Both boards are made with standard 8-layer technology and the material is FR-4. The PCB stack-up information is shown in <u>Table 7</u> and <u>Table 8</u>.

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Table 7. 8MNANOLPD4-CPU Board stack up information

Layer	Description	Coppoer (Oz.)	Dielectric thickness (mil)
1	Signal	0.5+Plating	
	Dielectric		2.76 mil
2	GND	1	
	Dielectric		2.95 mil
3	Signal	1	
	Dielectric		25.28 mil
4	Power	1	
	Dielectric		2.95 mil
5	Power	1	
	Dielectric		2.76 mil
6	Signal	0.5+Plating	
Total thickness:	47.24(4.72/-4.72) m	il	1.2 (+0.12/-0.12) MM
Material:	TU768		TU768

Table 8. 8MMINI-BB Board stack up information

Layer	Description	Coppoer (Oz.)	Dielectric thickness (mil)
1	Signal	0.5+Plating	
	Dielectric		2.77 mil
2	GND	1	
	Dielectric		4.33 mil
3	Signal	1	
	Dielectric		12.89 mil
4	Power	1	
	Dielectric		11.81 mil
5	Power	1	
	Dielectric		12.89 mil
6	Signal	1	
	Dielectric		4.33 mil
7	GND	1	
	Dielectric		2.77 mil
8	Signal	0.5+Plating	
Total thickness:	62.992 (6.299/-6.299) mil		1.6 (+0.16/-0.16) MM
Material:	TU768		TU768

## 3.1 EVK design files

You can download the schematics, layout files, gerber files, and BOM from i.MX 8M Nano.

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## 4 Revision history

Section 4 summarizes the revisions to this document.

Table 9. Revision history

Revision number	Release date	Description
2	19 September 2023	The document is updated to correspond ot the latest guidelines; Figure 1, Figure 2, Figure 6 are updated; minor text updates.
1	12/2020	Updated <u>Section 2.3</u> Updated <u>Table 7</u>
0	10/2020	Initial public release

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#### i.MX 8M Nano LPDDR4 EVK Board Hardware User's Guide

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